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	3. Nature of Conveyance:					
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	4. Application number(s) or patent number(s)	1-14-99				
	X This document is being filed together with a new app	neation				
	Execution date of the application: 03/11/98 & 03/16/98 Title Method for Fabricating Reliable Multilayer Bottom Elect Docket: TI-26559 Filing Date: 01/14/09	ode for Ferroelectric Capacitors				
	A. Patent Application No.(s)	B. Pater No.(s)				
	Additional numbers attached? YesXNo	Additional numbers attached Yes X No				
	5 Name and address of party to whom correspondence concerning document should be mailed: Name: Carlton H. Hoel Texas Instruments Incorporated Address: PO Box 655474, M/S 3999 City Dallas State Texas Zip: 75265	6. Number of applications and patents involved:11				
01/25/1999 04 FC:581	PBUTLER 00000035 200668 09231023 40.00 CH	7. Amount of fee enclosed or authorized to be charged: \$40 8. Deposit account number (Attach two copies of this form if paying by				
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_	Date Carlton H.	Hoel. Registration No. 29,934 Page 1 of 2				

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Additional name(s) attached? Yes _X_ No	City: Dallas					
	State. Texas Zip: 75265					
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4. Application number(s) or patent number(s).						
This document is being filed together with a new appi	This document is being filed together with a new appleation.					
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A. Patent Application No.(s)	B. Patent No.(s)					
Additional numbers attached? YesX_ No	Additional numbers attached?YesXNo					
Name and address of party to whom correspondence concerning document should be mailed:	6. Number of applications and patents involved1					
Name Carlton H. Hoel Texas Instruments Incorporated						
Address: PO Box 655474, M/S 3999						
(ity: Dallas						
State: Texas Zip: 75265						
	7. Amount of fee enclosed or authorized to be charged: \$40					
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M	MILLY					
Date Carlton H. F.:	pel, Registration No. 29,934					

Page 1 of 2

DOCKET NO	
П-16550-Р	

ASSIGNMENT

WHI REAS, we, the undersigned inventor (or one of the undersigned join inventors), of residence as listed, having invented certain new and useful improve neros as below entitled, for which application for United States Letters Patent is more techniques and application having been executed on the date set forth below; and

Letters Patent that may issue thereon;

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation—reganized and existing under the laws of the State of Delaware, with its principal office at 7839 Churchill Way, Dallas, Texas 75251, is desirous of acquiring our cutic right, title and interest in and to the said invention, and to the said application and and

INSTRUMENTS INCORPORATED, as assignee of our entire right, title and interest,

NOW. THEREFORE, for good and valuable consideration, the recent of which is hereby acknowledged, we hereby sell and assign to the said TLXAS INSTRUMENTS INCORPORATED, its successors and assigns, our entire right title and interest in and to the said invention and m and to the said application and safe patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as our interest is concerned to the said [1] XAS

in connection therewith necessary to perfect such patent rights.

We also hereby sell and assign to TEXAS INSTRUMENTS INCORPCRATED, its successors and assigns, our foreign rights to the invention disclosed it said. application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any offer papers

INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

We hereby further agree that we will communicate to said 1FXAS INS. RUMENTS INCORPORATED, or to its successors, assigns, and legal representative any facts known to our respecting said invention, and at the expense of saic assignce company, testify in any legal proceedings, sign all lawful papers, execute addivisional continuation, reissue and substitute applications, make all law ill oaths, and generally do everything possible to aid said TEXAS (NSTR) MIN) s

IN WITHESS WHEREOF, we hereunto set hand and seal this day and a ar-

THTL+ OF INVENTION	METHOD FOR FABRICATING RELIABLE MULTILAYER BOTTOM ELECTRODE FOR FERROELECTRIC CAP&CITORS				
SIGNATHRE OF INVENTOR(S)	(1) Katsuhus Cirtus Katsuhiro Aoki	(2) Li menniki Sidrodin Toi oyuki Sakoda	(3) ly 1 × + 1 1 (10) Yukio Fukuda		
l: ATI	March 11, 1998	, ant , 1, 1998	Charles Service		
RESIDENCE (City County, State)	2-9-1-208 Kohoku, 7 suchiura- shi. Ibaraki 300. Japan	4-1 -5-306 Azuma, Tsukuba, Ibanki 305, Japan	778 Funaishikawa, Tokai-mura, Nakagun, Ibaraki, Japan		
DATI APPLICATION EXECUTED	July 10, 1997	Jun 10 1999	To 19 19 19 19 19 19 19 19 19 19 19 19 19		

After recording return Assignment to:

Jim Brady

Texas Instrument: Incorporated P.O. Box 655474, M/S 3999

Dallas, TX 7526:

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